

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Virginia 22313-1450 www.uspto.gov

BIB DATA SHEET

CONFIRMATION NO. 1077

SERIAL NUME	DAT		E `´	, ,		GROUP ART UNIT		ATTORNEY DOCKET NO.		
10/569,942	10/569,942 02/28/2			438			2812		P29123	
APPLICANTS Akihiko Endo, Tokyo, JAPAN; Hideki Nishihata, Tokyo, JAPAN; ** CONTINUING DATA **********************************										
This application is a 371 of PCT/JP04/12633 09/01/2004 /SJN/										
** FOREIGN APPLICATIONS ************************************										
** IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 05/05/2008										
Foreign Priority claimed Yes No 35 USC 119(a-d) conditions met Yes No			Met after Allowance		STATE OR COUNTRY		SHEETS TOT DRAWINGS CLAI			INDEPENDENT CLAIMS
N	SEAHVOS IIKMANES Examiner's	SH/	/SJN/ Initials		JAPAN		3	6		1
ADDRESS										
GREENBLUM & BERNSTEIN, P.L.C. 1950 ROLAND CLARKE PLACE RESTON, VA 20191 UNITED STATES										
TITLE										
Method for Manufacturing Bonded Wafer										
							☐ All Fees			
	FEES: Authority has been given in Paper					☐ 1.16 Fees (Filing)				
	No to charge/credit DEPOSIT ACCOUNT No for following:						☐ 1.17 Fees (Processing Ext. of time)			
900							1.18 Fees (Issue)			
						Other				
						☐ Credit				